Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.013mm	3.8
4		Top Layer	Copper	0.035mm	
5		Dielectric	FR-4	1.500mm	4.5
6		Bottom Layer	Copper	0.035mm	
7		Bottom Solder	Solder Resist	0.013mm	3.8
8		Bottom Overlay			
9		Bottom Paste			
	Height: 1.595mm				